## **UG10268**

# S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

Rev. 1.0 — 7 July 2025

User guide

#### **Document information**

Information	Content
Keywords	S32Z280, 594EVB, Evaluation Board Solution
Abstract	This document highlights the functionality of the S32Z280-594EVB Evaluation Boards (EVBs) for use by software and hardware developers.



S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

## 1 Overview

The primary objective of this document is to highlight the functionality of the S32Z280-594EVB Evaluation Boards (EVBs) for use by software and hardware developers.

The EVBs provide a platform for evaluation and development of S32Z2 automotive products – facilitating hardware & software development and providing robust debug capabilities.

Please refer to the board schematics in conjunction to viewing this document.

- SCH-89954 (S32Z280-594EVB)
- SCH-54935 (S32X-MB)

As revisions change, some of the images may show slight differences from delivered boards. Schematics contain full change lists.

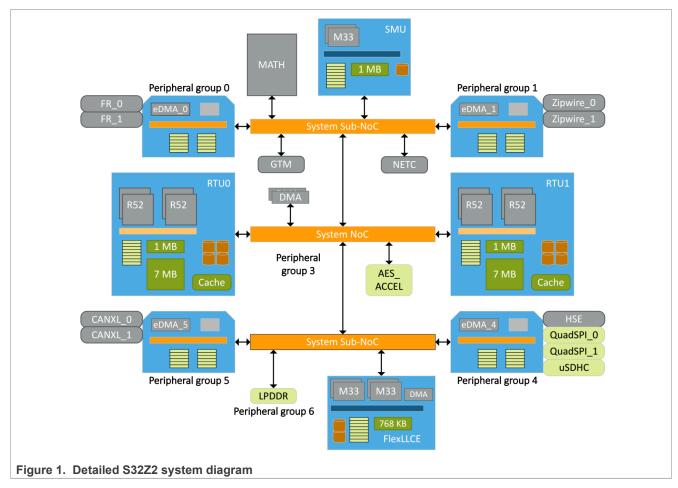


Figure 1 shows a system overview of the S32Z2 device. It is a high-end, 32-bit, Arm-based Microcontroller (MCUs), targeting applications related to safety, vehicle dynamics, domain control & HEV/EV systems. It has a wide feature set, requiring an extensive development platform for evaluating the functions available to a user.

This EVB solution was designed by NXP to allow silicon samples to be evaluated, with as much functionality pinned-out and available to the user as possible. In some cases, pins have been dedicated to a particular purpose on these EVBs and may not be available for alternate functions. Where possible, jumper configuration and on-board multiplexing allows for alternate functions to be evaluated.

## S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

The EVB system comprises a common motherboard (S32X-MB) and a daughtercard (S32Z280-594EVB). In this manual, the daughtercard used is the S32Z280-594EVB which is designed to support the S32Z2 which is one of the three unique package options for S32Z2/E2 family MCUs.

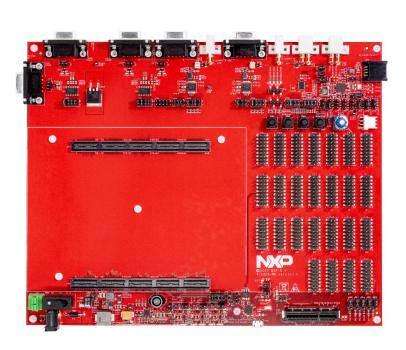


Figure 2. S32X-MB



Figure 3. S32Z280-594EVB daughtercard

The daughtercard attaches to the motherboard via long interconnectors on the bottom side of the S32Z280-594EVB daughtercard.

Figure 4 shows the placement of the board on top of the motherboard. The daughtercard extends past the left side of the motherboard. Support posts have been included in the daughtercard kit to support the weight of the overhanging edge of the daughtercard.

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide



Figure 4. MB and S32Z280-594EVB daughtercard

#### 2 Boot modes

#### 2.1 Boot mode types

This chapter provides details about different boot options available. This chip supports two boot modes:

- 1. Serial Boot mode from UART (LINFlexD) and CAN(FlexCAN)
- 2. Boot from external flash memory (from QuadSPI flash, SD, or MMC)

Combinations of the following inputs control the boot mode:

- Boot mode pins (BOOTMOD \_0 and BOOTMOD\_1)
- RCON switch Settings

#### 2.2 Serial boot mode

Serial Boot mode is entered via the BOOTMOD input pins. Serial download can also be initiated if the Functional Reset Counter (FREC register in the MC\_RGM module) reaches a value ≥ 8.

In Serial Boot mode, BootROM programs the HSE\_H SWT (Watchdog timer) for a 60 s timeout, then continuously polls for activity on any of the available interfaces:

- CAN
- UART

If no activity is detected, the timer expires, and the core is reset. BootROM sequentially checks for activity on all available interfaces and selects the first serial interface that it identifies as active as the download interface.

Jumpers J124 and J125 are BOOTMOD \_0 / BOOTMOD\_1.

BOOTMOD [1:2] = b01 to select serial boot mode.

UG10268

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

To select the Serial Boot Mode:

- 1. Switch OFF the power supply.
- 2. Set the jumpers as shown on the right:

J124 : Position (2-3)J125 : Position (1-2)

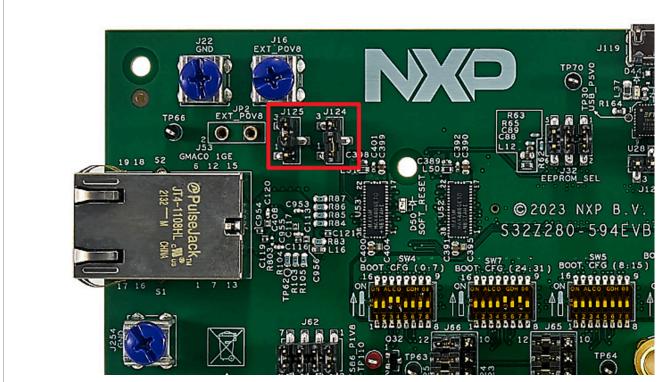


Figure 5. Jumpers J124 and J125 for boot mode selection

#### 2.2.1 FlexCAN

BootROM supports serial download from the FlexCAN module. Communication between the chip and the host (transmitting utility) is done by exchange of data using CAN packets. BootROM supports transfer of data only in non-FD mode.

#### 2.2.2 UART (LINFlexD)

BootROM supports boot from the LINFlexD\_9 module, configured in UART mode. The communication between the MCU and the host (transmitting utility) is done by exchange of data through UART packets. LINFlexD\_9 is configured to communicate in 8 bit mode with even parity configuration.

On the S32Z280-594EVB, the RCON1\_SEL signal is routed to the U54 by an error, thus J248 functions as the J247, and J247 is not populated. To select LINFlexD\_9 as UART, move J248 to 1-2 position.

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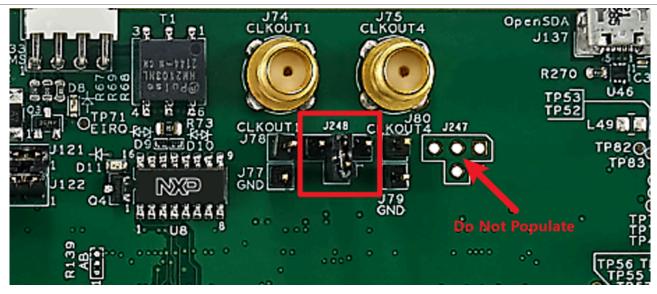


Figure 6. Jumper J248 for selecting LIN(9) for UART

**Note:** If doing parallel RCON boot, set the jumper to 2-3 position. By default, the jumper is placed at the 2-4 position, which the LIN\_SEL is software controlled.

## 2.3 Boot from external flash memory

BootROM supports boot from external flash memory devices over the following interfaces:

- QuadSPI Hyper Flash/LPDDR4 Flash
- SD via uSDHC interface

In order to boot from the external flash memory devices, the following selections need to be made:

- 1. Enable Parallel RCON boot.
- 2. Select the QSPI/SD boot modes.

To enable boot form parallel RCON:

- 1. Switch off the power supply.
- 2. Set the jumpers as shown in the above figure Boot Mode Selection Reference.
  - J124 : Position (1-2)
  - J125 : Position (2-3)

#### 2.3.1 QSPI boot mode

To enable QSPI boot mode:

- 1. Switch OFF the power supply.
- 2. Enable the parallel RCON boot.
- 3. Change the below RCON settings to select the corresponding flash memory:

QuadSPI_Mode	BOOT_CFG[4]	BOOT_CFG[3]	BOOT_CFG[2]
Quad Flash	0	0	0
HyperFlash	0	0	1
LPDDR4 Flash	1	1	1

UG10268

## S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

There are 32 dip switches for selecting the RCON configuration shown in the figure. BOOT\_CFG(0:31) Corresponds to RCON Switches 1 to 32.

- 1 Switch ON
- 0 Switch OFF

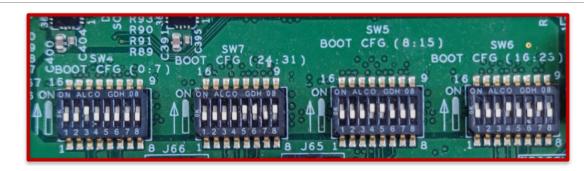


Figure 7. RCON switches

#### 2.3.2 SD via uSDHC interface

SD Boot device selection is controlled by BOOT\_CFG1[7:5] as shown in the following table. To change from QSPI boot mode to SD mode:

- 1. Switch OFF the power supply.
- 2. Enable the parallel RCON Boot.
- 3. Change the below RCON settings to select the corresponding SD/MMC boot:

Table 1. RCON settings to select the corresponding SD/MMC boot

<b>Boot Options</b>	BOOT_CFG[7]	BOOT_CFG[6]	BOOT_CFG[5]
SD Boot	0	1	0
Reserved	1	1	1

#### 2.3.3 Additional RCON settings for Clock/Speed/Phase for different boot configurations

For detailed RCON settings – see S32Z2\_Fuse\_map in the reference manual. Below RCON settings summarize the switch configuration:

Table 2. Additional RCON settings for Clock/Speed/Phase for different boot configurations

BOOT_ CFG[14]	BOOT_ CFG[13]	BOOT_ CFG[12]	BOOT_ CFG[11]	BOOT_CFG[10]	BOOT_CFG[9]	BOOT_ CFG[8]
	PI CAS (only valid 0-1111:QuadSPI_	<i>7</i> 1	,	CK2 0 : CK2 Clock not required 1: CK2 Clock required	Reserved	Serial RCON Detection 1: I2C connected as Serial RCON 0: Parallel RCON

## S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

BOOT_CFG[20]	BOOT_CF	G[19]	BOOT_ BOO CFG[18] CFG		_		_		_	BOOT_ CFG[16]	BOOT_ CFG[15]
LPDDR4_FLASH_ BNKAV_CFG 0 : No BNKAV config will be done 1: BNKAV config will be done	CKN 0 : Differential Clock not required 1: Differential Clock required	SD Speed 0 - Default Speed 1 - High Speed	QuadSPI P Delay 000: 30 001: 600us 010: 1000u 011: 2000us 100: 5000u 101: 50000u 111: 300000	Ousec sec sec sec sec sec usec	000: Clo 0 0 1 101 101 (only	Vait Period  No Wait 74  Cock Cycles  Oo1: 5ms  Oo1:10ms  Oo1:20ms  Oo:35ms  1:Reserved  Reserved  Soms (max)  for SD/MMC/  Configuration.	XOSC BYPASS MODE SEL ECTION: Selects XOSC Mode if XOSC Configuration Fuse is not blown. 0: Reserved 1: Crystal Mode				

MMC Boot Modes	BOOT_CFG[19]	BOOT_CFG[20]	BOOT_CFG[21]	BOOT_CFG[22]
		MMC E	oot Modes	
		0000- 1-bit	Normal Speed	
		0001 - 4-bit	Normal Speed	
		0010 - 8-bit	Normal Speed	
		0011- 1-bi	t HIGH Speed	
		0100 - 4-bi	t HIGH Speed	
		0101 - 8-bi	t HIGH Speed	
		0110 - 4-bit D	DR HIGH Speed	
		0111 - 8-bit D	DR HIGH Speed	

BOOT_CFG[23]	BOOT_CFG[22]	BOOT_CFG[21]
TDH : Time Hold Delay 00: I Internal reference clock 01: Da	•	Reserved

BOOT_ CFG[30]	BOOT_ CFG[29]	BOOT_ CFG[28]	BOOT_ CFG[27]	BOOT_ CFG[26]	BOOT_CFG[25]	BOOT_CFG[24]
01: Pad I	00: Reserved popback 10: : External DQS	by slave dela	: Selects the Nth y-chain. N can va LLFSMPF] in Qu	ary from 0 to 7.	FSDLY: Full Speed Delay selection. See SMPR[FSDLY] in QuadSPI chapter.	FSPHS: Full Speed Phase selection. See SMPR[FSPHS] in QuadSPI chapter.

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

## 3 Daughtercard

The daughtercard (DC) is fully capable of operating stand-alone (i.e. completely disconnected from the Motherboard) by means of on-board power management ICs and included 12V AC adapter, or by using external bench power supplies.

## 3.1 Default jumper settings (DC)

Figure 8 shows the default placement of jumpers across the entire board, with each red box highlighting the key jumpers for power supply selection and Boot mode selection. This is how the S32Z280-EVB board should look when initially removed from packaging.

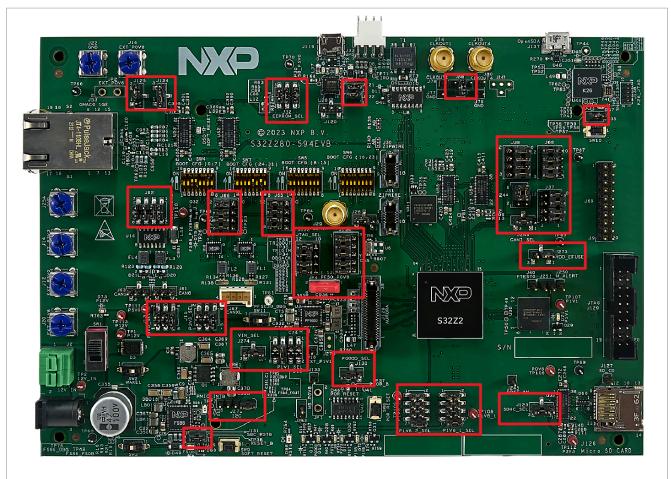


Figure 8. Highlighted default jumper settings

The table below provides an overview of all the jumpers available including their default position as well as the functionality of each jumper position.

Table 3. List of jumpers

Label from Schematic	Overall Function	Default Configuration	Pins	Pin description	Link to extended description
P1	12 Volt Power Connector	-	-	-	3.2.3
J2	12 Volt Terminal Block	-	-	-	3.2.3

UG10268

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## S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

Table 3. List of jumpers...continued

Label from Schematic	Overall Function	Default Configuration	Pins	Pin description	Link to extended description
JPx	0.8V power supply	Dependent on	JP1	MB Supply	3.2
	jumper	System Basis Chip on board	JP2	External Supply	
			JP4	PF5030 Supply	
J12	External 5.0V power plug	-	-	-	3.2.2
J13	5.0V power supply	Pins 5-6	1-2	MB Supply	3.2
	jumper		3-4	External Supply	
			5-6	SBC Supply	
J14	External 3.3V power plug	-	-	-	3.2.2
J15	3.3V power supply	Pins 5-6	1-2	MB Supply	3.2
	jumper		3-4	External Supply	
			5-6	SBC Supply	
J16	External 0.8V power plug	-	-	-	3.2.2
J20	External 1.8V power plug	-	-	-	3.2.2
J21	1.8V power supply	Pins 7-8	1-2	MB Supply	3.2
	jumper		3-4	External Supply	
			5-6	N/A	
			7-8	PF5030	
J22	External GND	-	-	-	3.2.2
J23	1.8V power supply			MB Supply	3.2
	jumper		3-4	External Supply	
			5-6	N/A	
			7-8	PF5030	
J28	Clock In	Pins 2-3	1-2	Enabled	3.3
			2-3	Disabled	
J29	CLOCKIN SMA	-	-	-	3.3
J33	EEPROM Select	1-2	1-2	То МВ	3.9
		3-4	3-4	To MB	
			5-6	EEPROM_SCL EEPROM_SDA	
J33	Battery Management System Interface	-	-	-	-
J53	GMAC0 1GE	-	-	-	3.10
J61	CAN0	Open	1	CAN0_P	3.6

## S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

Table 3. List of jumpers...continued

Label from Schematic	Overall Function	rall Function Default Pins Pin description Configuration		ription	Link to extended description			
				2	-			
				3	CAN0_N			
J63	CAN1	Open		1	CAN1_P		3.6	
				2	-			
				3	CAN1_N			
J67	CANXL	Open		1	CAN0XL_P		3.7	
				2	CAN0XL_N			
				3	CAN1XL_P			
				4	CAN1XL_N			
J74	CLKOUT1 SMA	-		-	-		3.3	
J75	CLKOUT4 SMA	-		-	-		3.3	
J77	GND	-		-	-		-	
J78	CLKOUT1 header	Open		1	CLKOUT1		3.3	
J79	GND	-		-	-		-	
J80	CLKOUT4 header	Open		1	CLKOUT4		3.3	
J119	USB Micro B	-		-	-		3.5	
J121 Enable TX LED		Pins 1-2 (On)		1	USB_TXLED		3.5	
				2	CBUS0		7	
J122	Enable RX LED	Pins 1-2 (On)		1	USB_RXLED		3.5	
				2	CBUS1			
J123	SDHC Select	Pins 2-3	1	-2	SDHC to MB		3.8	
			2	!-3	SDHC to SD Sc	ocket		
J124	BOOT_MODE0	Pins 1-2	1	-2	High		3.4	
			2	!-3	Low			
J125	BOOT_MODE1	Pins 2-3	1	-2	High		3.4	
			2	!-3	Low			
J127	SD_CD	Open		1	SD_DC		3.8	
J130	MB PGOOD_SEL	Pins 1-2	1	-2	MB Power Good	d	3.1	
			2	!-3	SBC Power Go	od		
			O	oen	External Power			
J131	SBC_RSTB	Pins 1-2 1		1	RESET_B		3.3.3	
			2		SBC_RSTB			
J132	JTAG_SEL	Pins 2-3	1	2-3	То МВ	J_TDI	3.11.2	
		Pins 5-6	4	5-6	То МВ	J_TDO		
		Pins 8-9	7	8-9	То МВ	J_TCK		

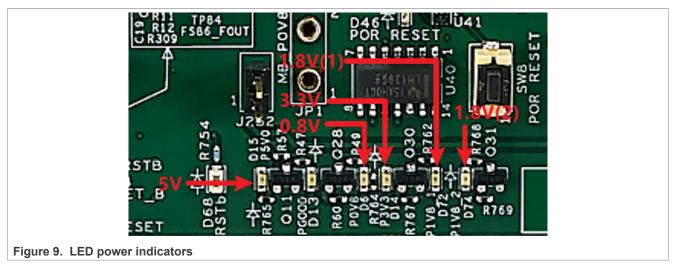
## S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

Table 3. List of jumpers...continued

Label from Schematic	Overall Function	Default Configuration	Pins		Pins		Pins		Pins		Pin descri	ption	Link to extended description					
		Pins 11-12	10	11-12	То МВ	J_TMS												
J134	JTAG or OpenSDA	Pins 1-2	3	1-2	To OpenSDA	To 20-pin	3.11											
		Pins 4-5	6	4-5	*OpenSDA is for Future Use	JTAG												
		Pins 7-8	9	7-8	Tatare osc													
		Pins 10-11	12	10-11														
		Pins 13-14	15	13-14														
J247*	LIN Select	Pins 2-3	1	-2	LIN6-9	3.5												
(Not populated, controlled by			2	2-3	RCON4, PSI5		1											
J248)			2-4		SOFT_RESET													
J248	RCON Select	Pins 2-3	1-2 MISC			3.4												
			2-3		RCON4, OpenSDA		1											
		2-4		2-4	SOFT_RESET													
J252	PF Power On	Open	1	-2	-		-											
J254	External GND	-		-	-		3.2.2											
J255	GMAC1 1GE	-		-	-		3.10											

## 3.2 Power supply

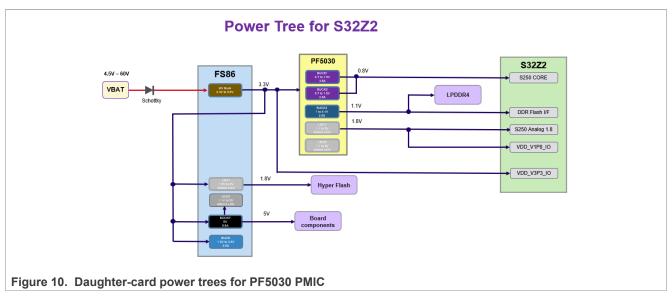
The EVB has five distinct power rails. They are: 5V, 3.3V, 1.8V(1), 1.8V(2), and 0.8V. The purpose of each rail is shown by their connections in the above diagram. Each rail has an associated LED to signal when the power rails are working as intended, these will illuminate when power is successfully applied regardless of option used.



Note that by default, everything is configured to be powered by the S32Z280-594EVB power management ICs.

The S32Z280-400EVB features one System Basis Chip, the NXP FS86 series SBC, and the NXP PF5030 series PMICs. The following figure shows the power-tree connections.

#### S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide



**Note:** The motherboard does not supply 1.1V, so this must be sourced from the daughter-card's PMIC or external supply connector to supply the LPDDR power segment.

Figure 11 shows power selection jumpers on the S32Z280-594EVB daughtercard.



Figure 11. JPx jumper



Figure 12. Physical power supply selection jumper

#### S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

Figure 12 shows possible supply options for each power rai. For the 0.8V power rail, the big red jumper (Figure 11) can be moved to switch between the motherboard, external supply, or PF5030.

Table 4. 0.8V Power supply options

Jumper Placement	Voltage Supply Source
JP1	Motherboard
JP2	External Supply
JP4	PF5030

Next, J13 corresponds to the supply options for 5.0V. The table below demonstrates the possible placement of the jumper in order to receive the desired supply of 5.0V.

Table 5. 5.0V Power supply options

Jumper Placement	Voltage Supply Source
Pins 1-2	Motherboard
Pins 3-4	External Supply
Pins 5-6	System Basis Chip

Additionally, J15 corresponds to the supply options for 3.3V. The table below demonstrates the possible placement of the jumper in order to receive the desired supply of 3.3V.

Table 6. 3.3V Power supply options

Jumper Placement	Voltage Supply Source
Pins 1-2	Motherboard
Pins 3-4	External Supply
Pins 5-6	System Basis Chip

J19 corresponds to the supply options for 1.1V. The table below demonstrates the possible placement of the jumper in order to receive the desired supply of 1.1V.

Table 7. 1.1V Power supply options

Jumper Placement	Voltage Supply Source
Pins 1-2	External Supply
Pins 3-4	N/A
Pins 5-6	PF5030
Pins 7-8	FS86

J21 and J23 correspond to the supply option for 1.8V. Two separate jumpers are needed in order to deliver the proper 1.8 power supply. It is important to note that pins 5-6 and pins 7-8 correspond the two different options of possible PMICs on the S32Z280-594EVB. The board will only have one PMIC, so place the jumper on the pins that correspond to the PMIC on the S32Z280-594EVB if supplying from the PMIC is desired. The tables below demonstrate the possible placement of the jumpers in order to receive the desired supply of 1.8V.

Table 8. 1.8V Power supply options

Jumper Placement	Voltage Supply Source
Pins 1-2	Motherboard
Pins 3-4	External Supply

UG10268

## S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

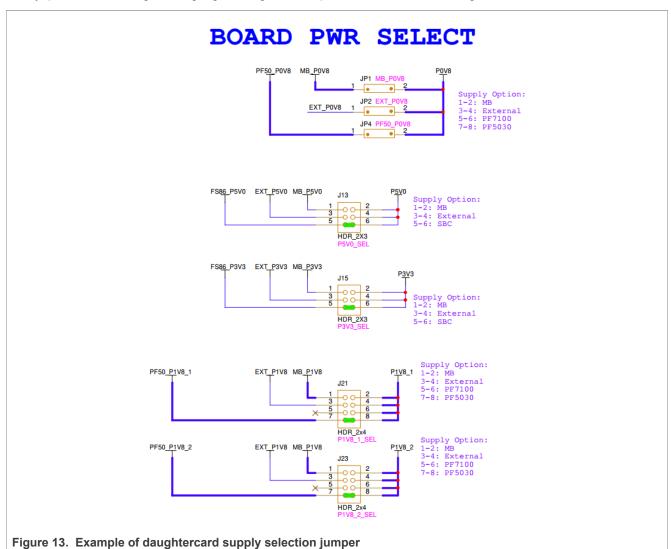
Table 8. 1.8V Power supply options...continued

Jumper Placement	Voltage Supply Source
Pins 5-6	N/A
Pins 7-8	PF5030

Table 9. 1.8V Power supply options

Jumper Placement	Voltage Supply Source
Pins 1-2	Motherboard
Pins 3-4	External Supply
Pins 5-6	N/A
Pins 7-8	PF5030

Lastly, please note the green highlight in Figure 13 represents the default configuration of the board.



S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

#### 3.2.1 Power from motherboard

The primary purpose of the motherboard when used with the daughter-cards is to provide additional IO pin-out and communication transceivers, however, it is also capable of supplying 5V, 3.3V, 1.8V, and 0.8V from its own regulators. As noted previously, the motherboard does not supply 1.1V for DCs requiring LPDDR power.

It is recommended to use the daughter-card power supplies since they include all necessary power segments for each DC. It is possible, however, to select the source of each power rail individually if so desired.

#### 3.2.2 Power from multiple external supplies

To power the daughtercard from individual external supplies, e.g., a bench supply unit, each rail must be plugged into its corresponding screw terminal, and the power selection jumpers for each rail connected as shown in Figure 12 excerpt to select "External" power option in each case.

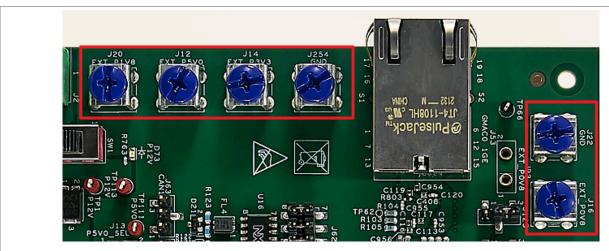


Figure 14. Contacts for individual external supplies

#### 3.2.3 Power from SBC/PMIC

On the EVB we use the NXP FS86 SBC in conjunction with the PF5030 PMIC.

To receive all power rails from a single external supply, a 12V source must be plugged into the daughtercard via barrel jack P1 or terminal block J2. The 12V supply is used to power the SBC which, together with the PMIC, generates all the required voltages.



Figure 15. 12V connections into FS86 SBC

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The SBC and PMIC are pre-programmed via fuses to provide the required voltages and correct power sequence.

## 3.2.4 SBC/PMIC debug mode

The SBC/PMIC solution includes hardware watchdogs that can reset the board and MCU if not serviced by application software. Normally, during development, it is desirable to disable this feature to allow application debug without interference from the watchdogs. This is accomplished by setting SW3 and SW11 to the "ON" position.

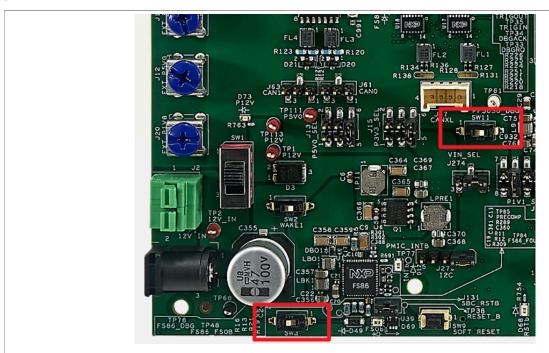


Figure 16. SBC and PMIC debug jumpers

#### 3.3 Clock and reset

## 3.3.1 Clocking

There are three clocking options on the daughtercard, configured by R59 and R807. R59 has two configurable positions, connect 1-2 or connect 3-2, or can be left unpopulated (this is the default). R807 is initially installed but can be removed to use external clock options.

#### S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

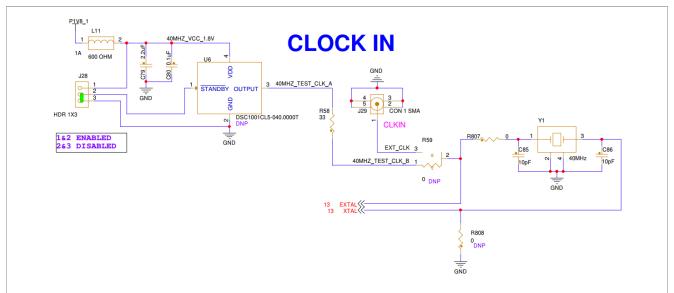


Figure 17. DC clocking configuration schematic

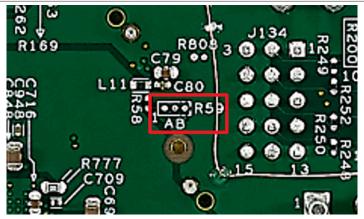


Figure 18. Physical DC clocking configuration-1

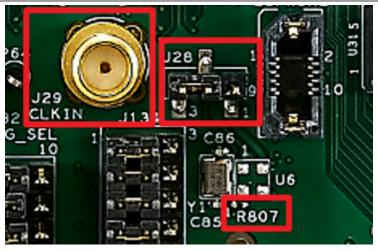


Figure 19. Physical DC clocking configuration-2

The clocking options on the EVB are as follows:

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

## 3.3.1.1 40MHz crystal

To use the 40MHz clock from the crystal, R59 must be left unpopulated, and R807 must be installed. This is the default configuration.

#### 3.3.1.2 40MHz OSC

To use the 40MHz clock from the oscillator chip, R59 must be configured in position 1-2, and R807 must be removed. Header J28 can then be used to enable the chip, by connecting pins 1&2.

#### 3.3.1.3 External SMA

To use an external clock with a custom frequency, R59 must be configured in position 3-2, and R807 must be removed. The external clock is connected to the SMA connector J29.

Table 10. Summary of resistor positions for different clocks

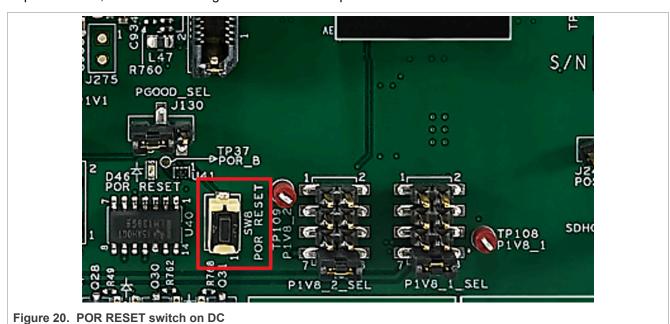
Clock Source	R59	R807
40MHz Crystal	Removed	Installed
40MHz OSC	1-2	Removed
External SMA	3-2	Removed

#### 3.3.2 Reset

The daughtercard contains two reset switches: POR RESET and SOFT RESET.

#### **3.3.2.1 POR RESET**

The open-drain POR\_B pin on the S32Z280-594EVB is a device reset source which can be externally triggered using the POR RESET switch on the daughtercard, or driven low by the SBC if it is determined that the device requires a reset, due to a low-voltage condition for example.



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When operating from an external power supply, header J130 must be opened for correct operation of the POR RESET switch.

#### 3.3.2.2 Functional Reset

To trigger a functional reset, the SOFT\_RESET switch on the daughtercard is used. This triggers a signal to SOFT\_RESET and RESET\_B. When operating from an external power supply, header J131 must be opened for correct operation of the SOFT\_RESET switch.



Figure 21. Soft reset switch and J131 on S32Z280-594EVB daughtercard

#### 3.4 RCON switches

There are four banks of dip switches on the DC, each with eight switches, giving a total of 32 switches in total. These switches are used for configuring the boot options of the S32Z2 device. To boot from Flash and allow for debug connection the switches should be placed in the correct positions as described in the boot modes section:



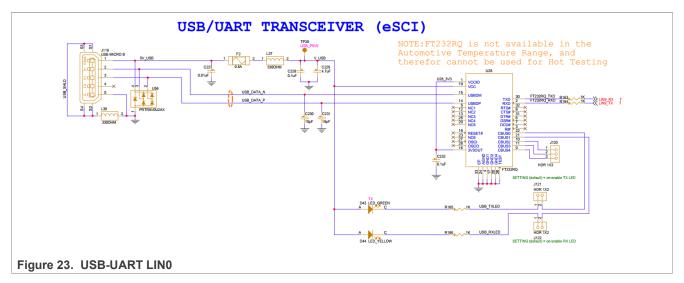
Figure 22. Default RCON switch positions for flash boot

Users should only change these default values if they are familiar with the boot processes of the device and wish to alter these booting source/conditions.

#### 3.5 LIN

The S32Z2's LIN9 interface is dedicated to the daughter-card USB-UART. This interface may also be used as a serial boot source.

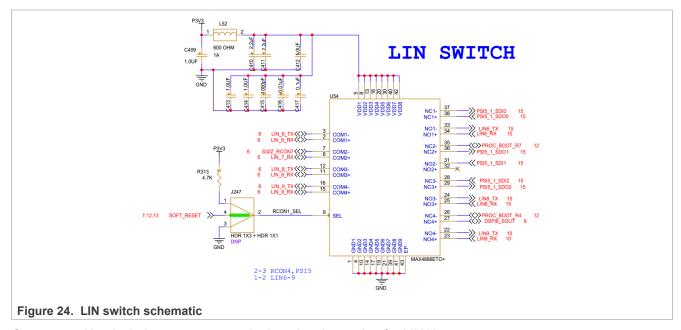
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The S32Z2's remaining LIN interfaces are multiplexed with alternate functions. Routing of LIN signals is accomplished via several on-board multiplexers and jumper blocks.

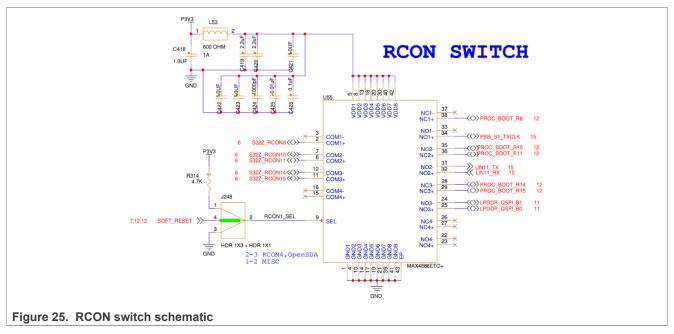
Component U54 provides selecting between LIN signals and a combination of RCON and PSI-5 signals.

**Note:** On the S32Z280-594EVB, the RCON1\_SEL signal is routed to the U54 by an error, thus J248 functions as the J247, and J247 is not populated. To select LINFlexD\_9 as UART, move J248 to 1-2 position.

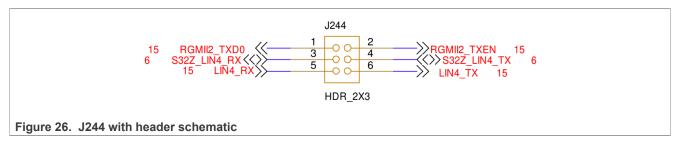


Component U55 includes among several other signals, routing for LIN11.

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Jumper J244 routes MCU LIN4 pins to either LIN4 or Ethernet RGMII functions.



#### 3.6 CAN

Header J62 is used to connect CAN0 and CAN1 instances to CAN-FD transceivers on the daughter-card. CAN bus-level signals are then available on pin headers J61 and J63 for these two CAN instances.

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide



Figure 27. Daughtercard CAN0 and CAN1 connectors

The CAN0 interface also allows the user to perform a serial boot even when using the daughtercard stand-alone (disconnected from the motherboard).

Remaining CAN interfaces not dedicated to other functions on the daughter-card, are routed to the motherboard connectors.

#### 3.7 CAN-XL

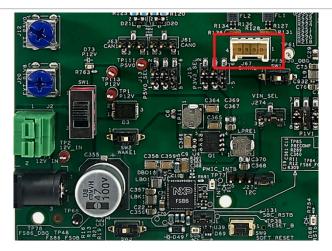


Figure 28. CANXL connector

S32Z280-594EVB includes two CAN modules supporting the upcoming CAN-XL standard. The daughter-card has reserved space for two NXP CAN-XL transceivers to be released soon. Signals CANXL\_0\_RX/TX and CANXL\_1\_RX/TX are routed to SO-14 package footprints with CAN bus physical signals available on jumper J67.

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

#### **3.8 SDHC**

An alternative solution for booting is to use an SD card. For this use, the daughtercard contains a micro SD card socket. J123 is used to switch the device's SDHC connection to either this micro SD card socket (connect pins 2 and 3), or the GPIO headers on the motherboard (connect pins 1 and 2).

Table 11. MCU GPIO pin numbers for SDHC signals

SDHC Signal	MCU GPIO Pin
SD_CLK	GPIO111
SD_CMD	GPIO106
SD_DATA0	GPIO107
SD_DATA1	GPIO108
SD_DATA2	GPIO109
SD_DATA3	GPIO110

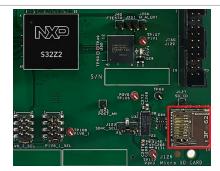


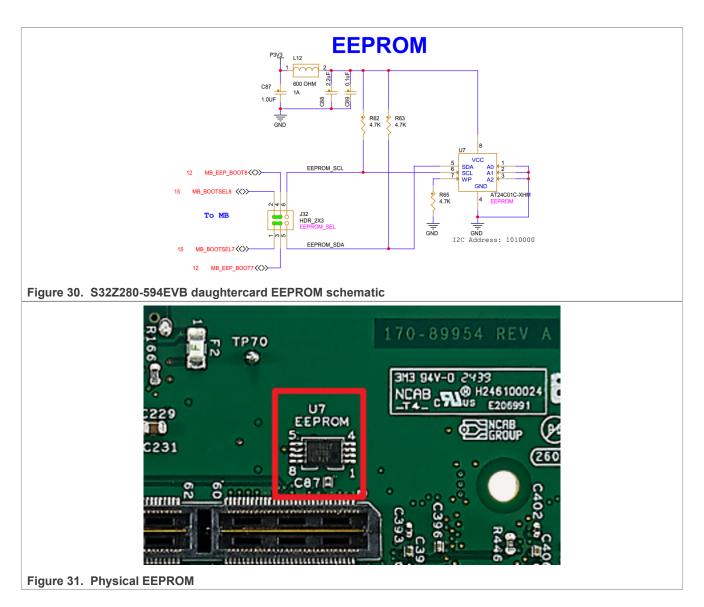
Figure 29. Micro SD socket

This is an alternate solution for booting where this interface can be used to perform a boot from the SD card.

#### 3.9 EEPROM

Header J32 is used to connect MCU GPIO pins to either the motherboard (default configuration), or to SDA and SCL of the daughtercard's EEPROM chip, allowing I2C access to the 8192 bits of serial Electrically Erasable and Programmable Read-Only Memory (EEPROM) located in chip U7. This provides support for Serial RCON, allowing the user to store boot configuration and load with Serial RCON via I2C, an alternative that uses fewer pins than the parallel RCON option.

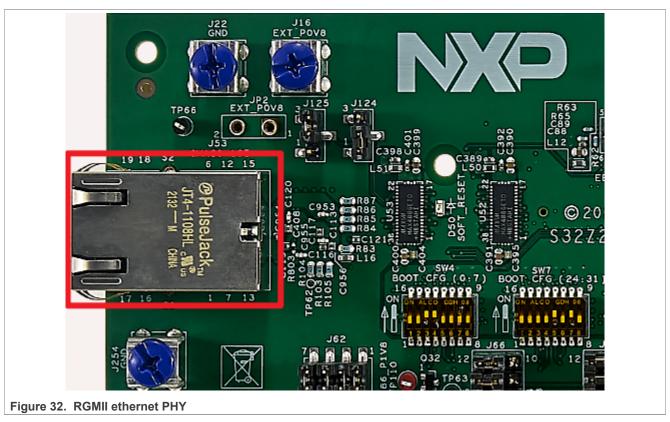
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## 3.10 Ethernet

The daughtercard includes one 1Gbps RGMII Ethernet PHY (U12) connected to ETH0 interface on the MCU:

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide



The ETH1 instance can be routed to the motherboard's 10/100 Mbps Ethernet PHY.

## **3.11 Debug**

#### 3.11.1 Aurora

The daughtercard contains a connector (J128) for the Aurora Trace Port, allowing debug information to be sent over a high-speed serial link. The five differential pairs from the connector (four TX and one Clock) are connected directly to the MCU.

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

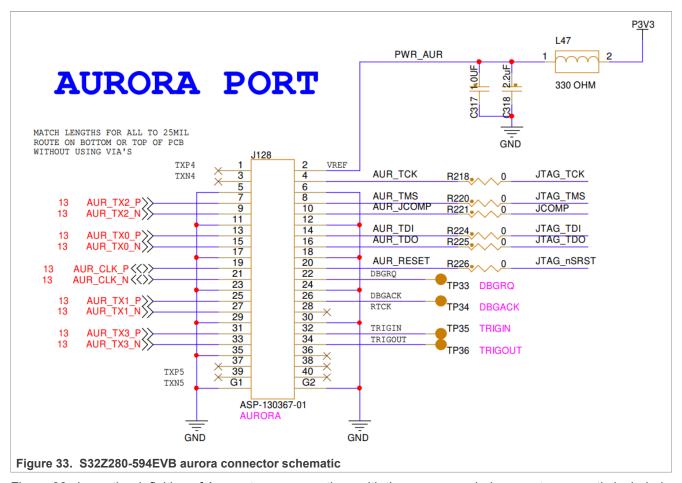


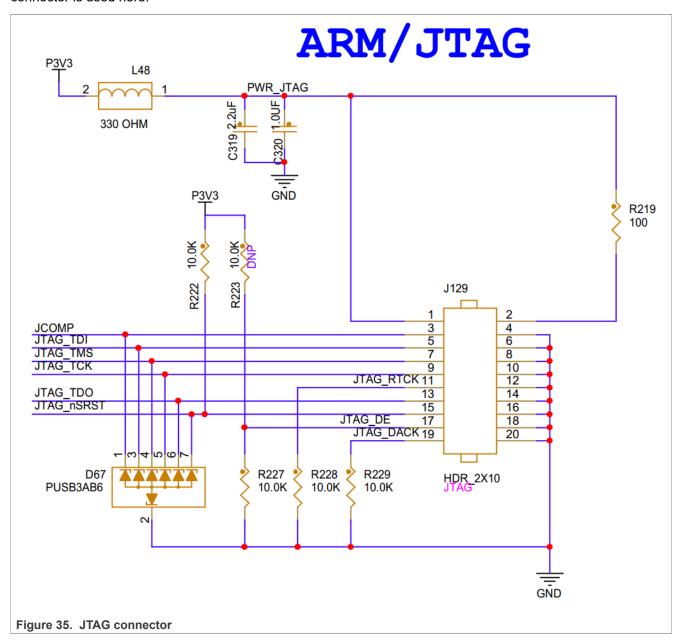
Figure 32 shows the definition of Aurora trace connections with the recommended connector currently included on the EVB.

	Connector Signal	Recommended Connection	Pin Number	Pin Number	Recommended Connection	Connector Signal	
	GND		La	tch		GND	
1	(TXP[4]) {+}	N/C	1	2	VDD_IO_AUR 3.3V	VREF	
2	(TXN[4]) {-}	N/C	3	4	N/C	TCK*	
3	GND	GND	5	6	GND	GND	
4	TXP[2] {+}	TXP[2]	7	8	N/C	TMS*	
5	TXN[2] {-}	TXN[2]	9	10	N/C	TDO*	
6	GND	GND	11	12	N/C	JCOMP (nTRST) *	
7	TXP[0] {+}	TXP[0]	13	14	N/C	TDI*	'S ZUMOODE
8	TXN[0] {-}	TXN[0]	15	16	N/C	TDO*	
9	GND	GND	17	18	GND	GND	
10	CLKP {+}	CLKP	19	20	]	RESET-	
11	CLKN {-}	CLKN	21	22	N/C	DBGRQ	200
12	GND	GND	23	24	GND	GND	
13	TXP[1] {+}	TXP[1]	25	26	N/C	DBGACK	4000 a
14	TXN[1] {-}	TXN[1]	27	28	N/C	RTCLK	
15	GND	GND	29	30	GND	GND	•
16	TXP[3] {+}	TXP[3]	31	32	N/C	TRIGIN	C ACD 420207 04
17	TXN[3] {-}	TXN[3]	33	34	N/C	TRIGOUT	Samtec ASP-130367-01
18	GND	GND	35	36	N/C	RESERVED	
19	(TXP[5]) {+}	N/C	37	38	N/C	RESERVED	
20	(TXN[5]) {-}	N/C	39	40	N/C	RESERVED	
	GND		La	tch		GND	

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

#### 3.11.2 JTAG

A JTAG debug port is included on the daughtercard (J129). The standard 20-pin 2.54mm (0.10") JTAG connector is used here.



## 3.11.3 Lauterbach Debuggers

The Lauterbach debug hardware for Aurora and JTAG setup for use with S32Z2 devices is as follows:

- LA-3520 + LA-3521 + LA3505 + LA3000
  - Up to 6 lanes (LA-3522 supports 8)
  - Up to 12.5 Gbps/lane

#### S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide



Figure 36. Lauterbach hardware setup

## 3.11.4 OpenSDA

There is an OpenSDA interface included on the board. However, **by default the chip required to use this interface is not populated**. It is an option to have the module soldered once the proper support is made available for OpenSDA debugging.

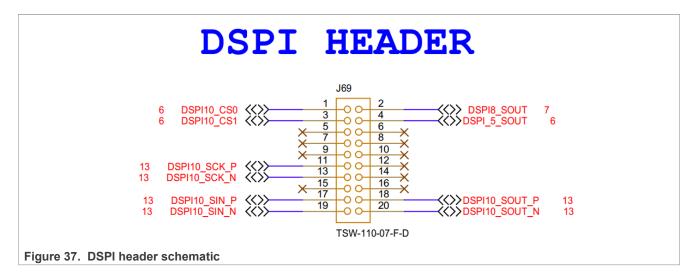
### 3.11.5 Other

Aurora trace tools are also available from other vendors, such as Green Hills and PLS. JTAG only tools are available from multiple vendors, including NXP and Green Hills.

#### 3.12 SPI

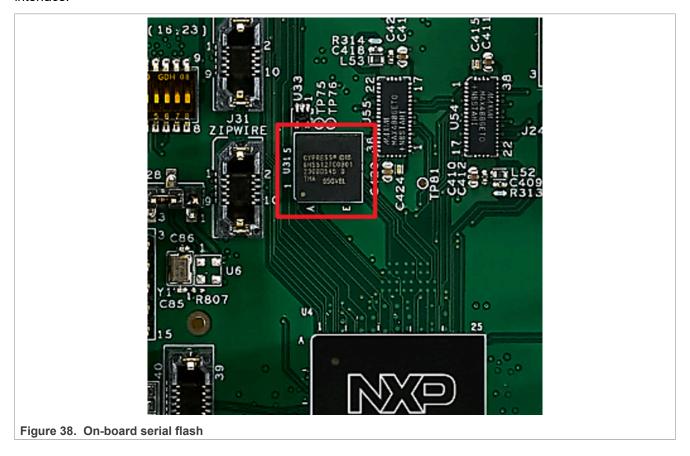
DSPI 10 is available on the daughter-card on J69 as well as SOUT signals for DSPI8 and DSPI5. The remaining DSPI instances are routed to pins on the motherboard.

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

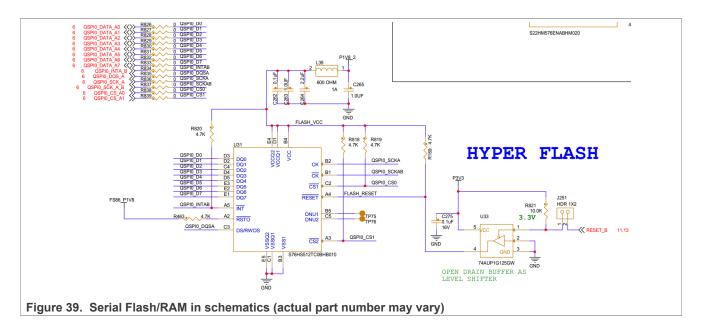


#### **3.13 FLASH**

The QSPI0 interface is connected to an on-board serial Flash/RAM device which may be used as a boot interface.

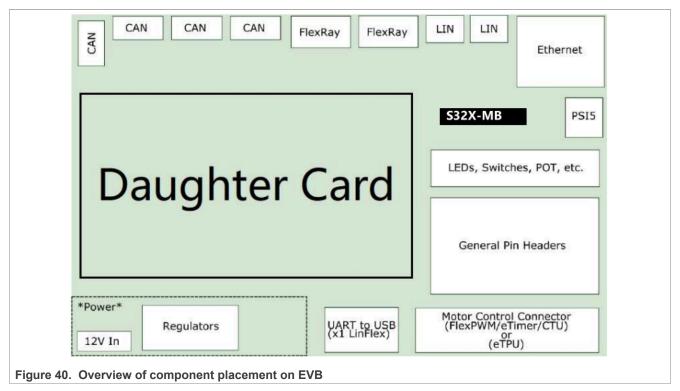


#### S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide



#### 4 Motherboard

Figure 34 shows the general placement of components of the motherboard. Please refer to Appendix B at the bottom of this document for a full overview.

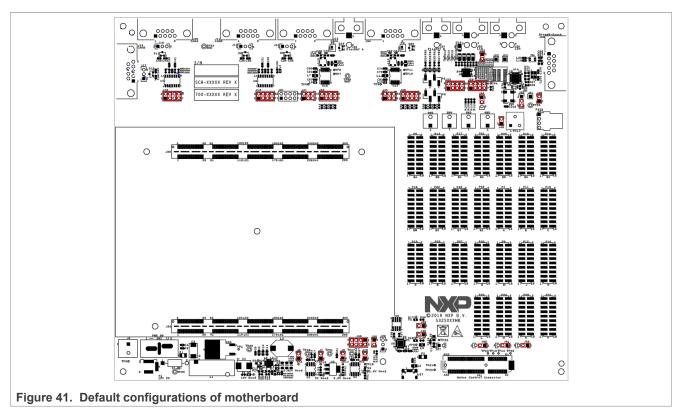


Default Jumper Settings (MB)

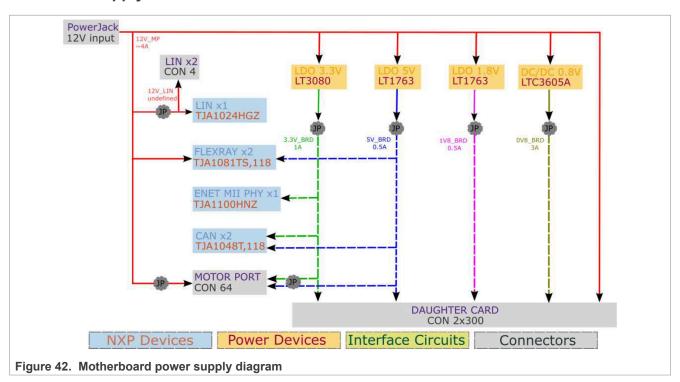
Figure 39 shows the default placement of jumpers for the entire motherboard, with each red box notating the placement of each jumper. This is how the motherboard should look once removed from the packaging. Note

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

that there may slight differences between new boards, since some of the jumper placements are done by hand at manufacture.



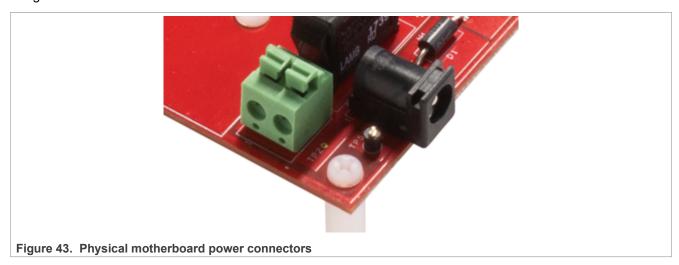
## 4.1 Power supply



#### S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

The motherboard is powered from a 12V supply, via either the barrel jack connector P1 or the terminal block J6). The 12V supply is used to supply regulators for power rails: 5V, 3.3V, 1.8V and 0.8V, each with a corresponding status LED to show that the rail is working properly.

Note that S32Z280-594EVB requires 1.1V supplied for LPDDR power. The Motherboard does not include a regulator for 1.1V. This must be supplied either on the daughter-card's external supply inputs or using the daughter-card's on-board SBC/PMIC.



Headers J7-J10 are set by default to enable the distribution of power from each regulator – removing the jumper isolates the rail from the motherboard.

Table 12. Enable/disable headers for MB power rails

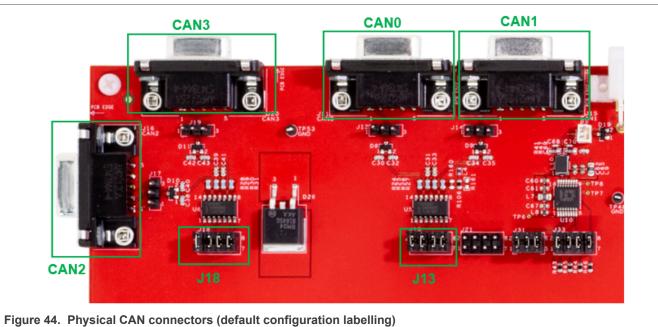
Power Rail	Enable/Disable Header
5V	J7
0.8V	J8
3.3V	J9
1.8V	J10

#### 4.2 CAN

The S32Z2 device has 24 FlexCAN modules implementing the CAN 2.0B and FD CAN protocols.

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

#### 4.2.1 CAN 0-3



The EVB motherboard contains four CAN connectors and two TJA1048 transceiver modules – each module providing a dual high-speed interface between the physical two-wire CAN buses and the protocol controller of the MCU. TJA1048 supports CAN FD up to 5Mbps for the data phase.

The TX/RX outputs of the TJA1048 modules are connected by default via J13 and J18 to CAN ports 2-5 of the MCU, also available as the following GPIO pins, both available on the general access headers on the motherboard, and connected to the daughtercard. The Motherboard schematic lists these CAN interfaces as CAN0 through CAN3, however they are connected to CAN instances 2-5 on the MCU Daughter-card. The following table shows this mapping and also the MCU GPIO pin number for each signal.

Table 13. Default DC CAN mapping and MCU GPIO pin numbers for MB CAN instances 0-3

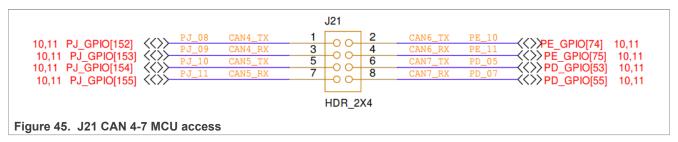
MB CAN Signal	DC CAN Signal	MCU GPIO Pin		
CAN0_TX	CAN5_TX	GPIO76		
CAN0_RX	CAN5_RX	GPIO77		
CAN1_TX	CAN4_TX	GPIO114		
CAN1_RX	CAN4_RX	GPIO115		
CAN2_TX	CAN2_TX	GPIO24*		
CAN2_RX	CAN2_RX	GPIO25*		
CAN3_TX	CAN3_TX	GPIO34		
CAN3_RX	CAN3_RX GPIO35			

\*CAN2\_TX requires a jumper in the 8-9 position and CAN2\_RX requires a jumper in the 11-12 position on J68 on DC.

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

#### 4.2.2 CAN 4-7

Header J21 provides direct access to CAN ports 6,7,9, and 10 of the MCU, with no transceiver module. However, jumper wires can be used to connect any of these ports to the inputs/outputs of the TJA1048 modules as described in Section 5.2.1 via headers J13 and/or J18.



The motherboard schematic lists these CAN interfaces as CAN4-7 but they are mapped to CAN instances 6, 7, 9, and 10 on the MCU as follows:

Table 14. MCU CAN instance and GPIO pin numbers for MB CAN instances 4-7

CAN Signal	MCU GPIO Pin	MCU GPIO Pin
CAN4_TX	CAN6_TX	GPIO138
CAN4_RX	CAN6_RX	GPIO117
CAN5_TX	CAN7_TX	GPIO118
CAN5_RX	CAN7_RX	GPIO109*
CAN6_TX	CAN10_TX	GPIO146**
CAN6_RX	CAN10_RX	GPIO147**
CAN7_TX	CAN9_TX	GPIO159***
CAN7_RX	CAN9_RX	GPIO160***

<sup>\*</sup>CAN7\_RX requires Jumper J249 in the 2-3 position on DC.

#### 4.3 LIN

S32Z2 contains 13 LINFlexD modules, LIN 0-11 and MSC\_0\_LIN. The EVB contains connections to four of these modules as well as a <a href="https://doi.org/10.24">TJA1024</a> quad LIN transceiver module, interfacing between the physical LIN buses and the protocol controller of the MCU.

<sup>\*\*</sup>CAN10\_RX requires a jumper in the 7-8 position and CAN10\_TX requires a jumper in the 10-11 position on J66 on DC.

<sup>\*\*\*</sup> CAN9\_RX requires a jumper in the 4-5 position and CAN9\_TX requires a jumper in the 1-2 position on J65 on DC.

#### S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

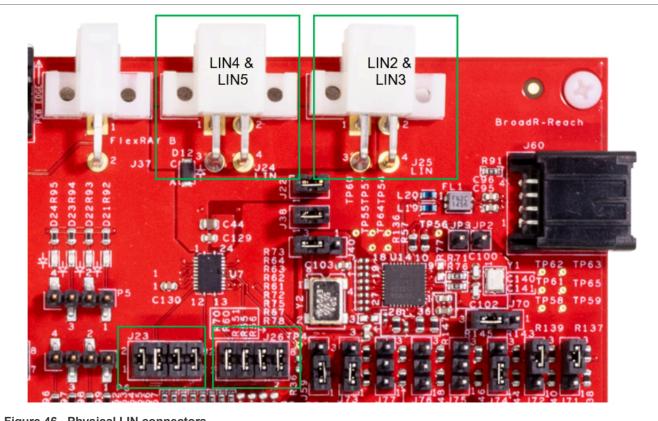


Figure 46. Physical LIN connectors

The four LIN ports are connected by default via J23 & J26 to LIN instances and GPIO pins on the MCU, both available on the general access headers on the motherboard and connected to the daughtercard. In the motherboard schematic, these four LIN ports are referred to as LIN2-5. The following table maps these LIN instances to the LIN modules on the MCU and associated GPIO pins.

**Note:** Motherboard LIN3 is not directly connected to the daughter-card due to routing constraints. However, it is possible to connect to the general access headers with J26.

Table 15. MCU LIN module and GPIO pin numbers for MB LIN signals

and the model and the pin name of the pin name of the man and the				
Motherboard LIN	MCU LIN Signals	MCU GPIO Pin		
LIN2_TX	LIN8_TX	GPIO125		
LIN2_RX	LIN8_RX	GPIO126		
LIN3_TX	Not Connected	Not Connected		
LIN3_RX	Not Connected	Not Connected		
LIN4_TX	LIN4_TX	GPIO47*		
LIN4_RX	LIN4_RX	GPIO48*		
LIN5_TX	LIN5_TX	GPIO36		
LIN5_RX	LIN5_RX	GPIO37		

<sup>\*</sup>LIN4\_RX requires Jumper in the 3-5 position and LIN4\_TX requires Jumper in the 4-6 position on J244 on DC.

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

#### 4.4 USB/UART

The USB/UART section of the motherboard allows the user to connect to the board and start up a serial terminal with just a USB cable, avoiding the need for any RS232 to USB converters (USB types may change between board revisions).

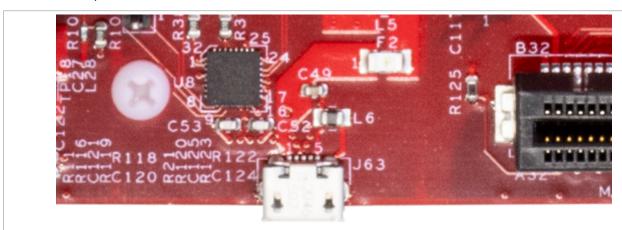


Figure 47. J63 UART Connector

#### 4.5 FlexRay

S32Z2 contains two FlexRay communication controller modules that implement FlexRay Protocol Specification 2.1A. The connectors available on the EVB are J32 for FlexRay\_A, J37 for FlexRay\_B, and J34 for a joint connection. The EVB contains a <a href="TJA1081">TJA1081</a> transceiver module for each FlexRay, providing an advanced interface between the physical buses in the network and the protocol controller of the MCU.



Header J31 for FlexRay\_A and J35 for FlexRay\_B are used to enable and route the FlexRay signals from the transceiver modules to the following GPIO pins, both available on the general access headers on the motherboard and connected to the daughtercard. The following table maps motherboard FlexRay signals to MCU FlexRay instances and GPIO pins.

Table 16. MCU GPIO pin numbers for FlexRay signals

MB FlexRay Signal	MCU FlexRay Signal	MCU GPIO Pin
FLXR0A_TXEN	FR_0_TXE_A_B	GPIO6

UG10268

## S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

Table 16. MCU GPIO pin numbers for FlexRay signals...continued

MB FlexRay Signal	MCU FlexRay Signal	MCU GPIO Pin
FLXR0A_TXD	FR_0_TXD_A	GPIO7
FLXR0A_RXD	FR_0_RXD_A	GPIO 8
FLXR0B_TXEN	FR_1_TXE_A_B	GPIO15
FLXR0B-TXD	FR_1_TXD_A	GPIO16
FLXR0B-RXD	FR_1_RXD_A	GPIO17

Header J33 for FlexRay A and J36 for FlexRay B are used to configure the operating mode of the transceiver modules by setting pins STBN and EN. By default, both pins are high, so the module is operating in Normal mode. Using jumper wires, the following table shows the other possible configurations.

Table 17. TJA1081 FlexRay transceiver module mode select

Mode	STBN	EN
Normal	1	1
Receive Only	1	0
Go to Sleep	0	1
Sleep	0	0

Note that both pins have internal pull-down resistors, so if the jumpers are left floating the module will enter Sleep mode.

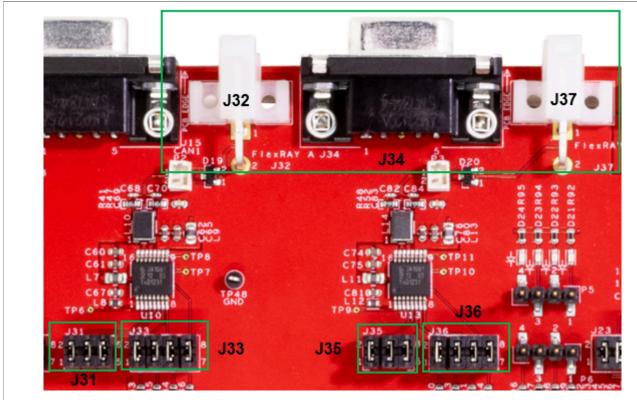


Figure 49. FlexRay connectors and enable and mode select jumpers

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

#### 4.6 Ethernet

S32Z2 contains one NET Controller (NETC) dual Ethernet module. It is capable of 10/100/1000 Mbps MII/RMII/RGMII.

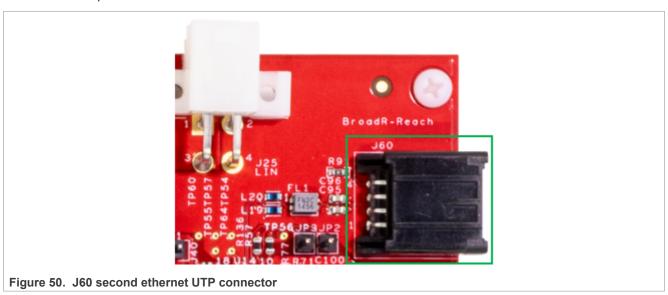
The S32Z2 daughtercard provides one Gigabit Ethernet PHY connected to ETH0 interface on the MCU. However, the motherboard contains a hard-placed <u>TJA1100</u> PHY, offering an additional ethernet port, connected to the following MCU GPIO pins available on the general access headers on the motherboard.

Table 18. MCU GPIO pin numbers for ethernet signals

MCU Ethernet Signal	MCU GPIO Pin
ETH_1_MII_RXD_0	GPIO54
ETH_1_MII_RXD_1	GPIO55
ETH_1_MII_RXD_2	GPIO56
ETH_1_MII_RXD_3	GPIO57
ETH_1_MII_TXER	GPIO42
ETH_1_MII_TXEN	GPIO47*
ETH_1_MII_TXD_0	GPIO48
ETH_1_MII_TXD_1	GPIO49
ETH_1_MII_TXD_2	GPIO50
ETH_1_MII_TXD_3	GPIO51
ETH_1_MII_TXCLK	GPIO46*
ETH_1_MII_RXDV	GPIO53
ETH_1_MII_RXER	GPIO43
ETH_1_MII_RXCLK	GPIO52

(\*) Note: Daughter-card jumper J244 must have connected 1-3 and 2-4 for TXEN and TXCLK signals.

The TJA1100 module implements the BroadR-Reach physical layer standard, providing the ability to receive/ transmit data over a single Unshielded Twisted Pair (UTP) cable, connected via J60 on the motherboard (i.e. no RJ45 connector).

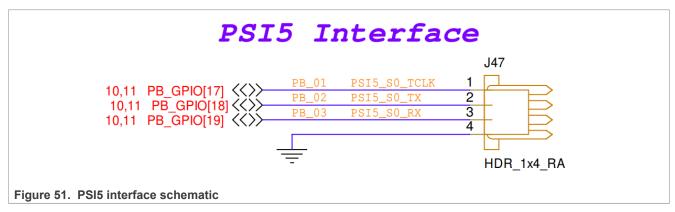


UG10268

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

#### 4.7 PSI5

There is one PSI5 instance from the S32Z2 accessible on the Motherboard. To connect to the PSI5 instance, connector J47 is used.

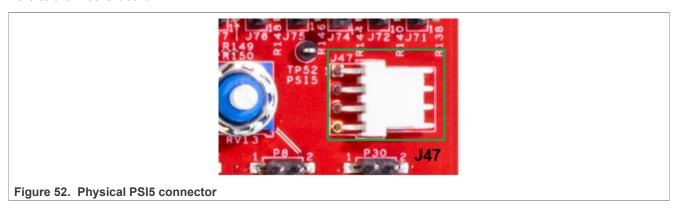


The MCU GPIO pins connected to J47 are as follows, both available on the general access headers on the motherboard, and connected to the daughtercard.

Table 19. MCU GPIO pin numbers for PSI5 signals

PSI5 Signal	MCU GPIO Pin
PSI5_S_0_TCLK	GPIO25
PSI5_S_0_TX	GPIO23
PSI5_S_0_RX	GPIO24

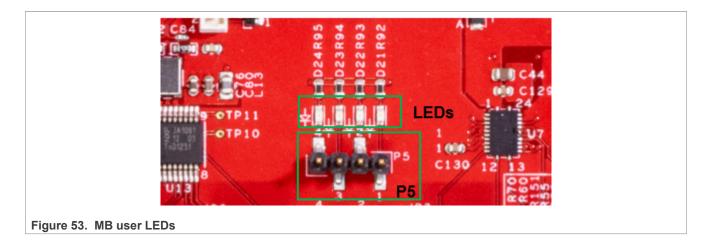
**Note:** Daughter-card jumper block J68 must have positions 1-5, 7-8, and 10-11 closed to route PSI5 signals here to the motherboard.



## 4.8 User LEDs

There are four yellow user LEDs on the MB, connected via header P5. Each LED will turn ON when its corresponding header pin is pulled to ground.

#### S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide



## 4.9 User Inputs

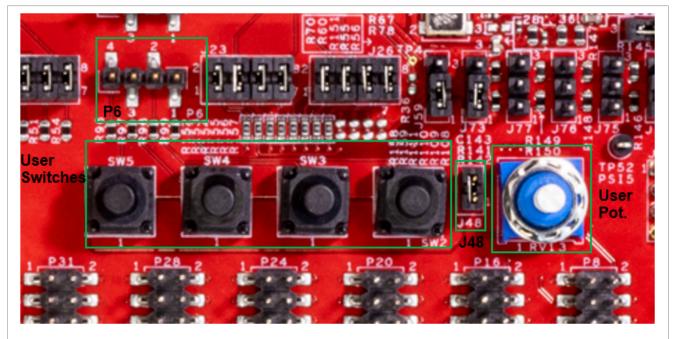


Figure 54. MB user inputs

## 4.9.1 Switches

There are four user pushbutton switches on the MB, each connected via header P6. User can connect any GPIO from the headers to P6 using jumper wires. When a switch is pressed the header pin is high (3.3V), and when released, the pin is low.

#### 4.9.2 Potentiometer

There is a 2K potentiometer on the MB, connected to header J48. This is not connected to any MCU pin on the daughter-card but is available on the general access headers on the motherboard. This is connected to analog ground for isolation.

S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

#### 4.10 Motor control

There is a separate motor control connector available on the motherboard, located in the bottom right of the board.

**Note:** This connector is not used with S32Z2 Family MCUs. A separate daughter-card, S32SE288-975EVB includes two motor-control connectors for use with NXP motor kits.





Figure 55. S32SDEV-CON motor control connector cable and socket

## 4.11 Other connectors

There are general access connectors available that allow easy access to MCU GPIO pins that are not dedicated to other purposes on the daughter-card.

This boiler plate is not ready for publication until the steps found in the Freescale Trademark Attribution Worksheet have been completed. You can access it here: <a href="http://compass.freescale.net/go/215485375">http://compass.freescale.net/go/215485375</a>

Note also that the ARM attribution must be updated from "ARMnnn" to reflect the correct product name.

## 5 Revision history

Table 20. Revision history

Document ID	Release date	Description
UG10268 v.1.0	07 July 2025	Initial release

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## S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

## **Tables**

lab. 1.	RCON settings to select the corresponding	_	Tab. 13.	Default DC CAN mapping and MCU GPIO	_
	SD/MMC boot	7		pin numbers for MB CAN instances 0-3	34
Tab. 2.	Additional RCON settings for Clock/Speed/	_	Tab. 14.	MCU CAN instance and GPIO pin numbers	
	Phase for different boot configurations			for MB CAN instances 4-7	35
Tab. 3.	List of jumpers		Tab. 15.	MCU LIN module and GPIO pin numbers	
Tab. 4.	0.8V Power supply options			for MB LIN signals	36
Tab. 5.	5.0V Power supply options		Tab. 16.	MCU GPIO pin numbers for FlexRay	
Tab. 6.	3.3V Power supply options			signals	37
Tab. 7.	1.1V Power supply options		Tab. 17.	TJA1081 FlexRay transceiver module	
Tab. 8.	1.8V Power supply options			mode select	38
Tab. 9.	1.8V Power supply options	15	Tab. 18.	MCU GPIO pin numbers for ethernet	
Tab. 10.	Summary of resistor positions for different			signals	
	clocks		Tab. 19.	MCU GPIO pin numbers for PSI5 signals	
Tab. 11.	MCU GPIO pin numbers for SDHC signals		Tab. 20.	Revision history	42
Tab. 12.	Enable/disable headers for MB power rails	33			
Figur	es				
Fig. 1.	Detailed S32Z2 system diagram	2	Fig. 29.	Micro SD socket	24
Fig. 2.	S32X-MB	3	Fig. 30.	S32Z280-594EVB daughtercard EEPROM	
Fig. 3.	S32Z280-594EVB daughtercard	3		schematic	25
Fig. 4.	MB and S32Z280-594EVB daughtercard	4	Fig. 31.	Physical EEPROM	25
Fig. 5.	Jumpers J124 and J125 for boot mode		Fig. 32.	RGMII ethernet PHY	26
	selection	5	Fig. 33.	S32Z280-594EVB aurora connector	
Fig. 6.	Jumper J248 for selecting LIN(9) for UART	6		schematic	27
Fig. 7.	RCON switches	7	Fig. 34.	Aurora trace connector definition	
Fig. 8.	Highlighted default jumper settings	9	Fig. 35.	JTAG connector	28
Fig. 9.	LED power indicators	12	Fig. 36.	Lauterbach hardware setup	
Fig. 10.	Daughter-card power trees for PF5030		Fig. 37.	DSPI header schematic	
	PMIC	13	Fig. 38.	On-board serial flash	30
Fig. 11.	JPx jumper	13	Fig. 39.	Serial Flash/RAM in schematics (actual	
Fig. 12.	Physical power supply selection jumper	13		part number may vary)	
Fig. 13.	Example of daughtercard supply selection		Fig. 40.	Overview of component placement on EVB	
	jumper		Fig. 41.	Default configurations of motherboard	
Fig. 14.	Contacts for individual external supplies		Fig. 42.	Motherboard power supply diagram	
Fig. 15.	12V connections into FS86 SBC		Fig. 43.	Physical motherboard power connectors	33
Fig. 16.	SBC and PMIC debug jumpers		Fig. 44.	Physical CAN connectors (default	
Fig. 17.	DC clocking configuration schematic			configuration labelling)	
Fig. 18.	Physical DC clocking configuration-1		Fig. 45.	J21 CAN 4-7 MCU access	
Fig. 19.	Physical DC clocking configuration-2		Fig. 46.	Physical LIN connectors	
Fig. 20.	POR RESET switch on DC	19	Fig. 47.	J63 UART Connector	
Fig. 21.	Soft reset switch and J131 on		Fig. 48.	Physical FlexRay connectors	37
	S32Z280-594EVB daughtercard	20	Fig. 49.	FlexRay connectors and enable and mode	
Fig. 22.	Default RCON switch positions for flash			select jumpers	
	boot		Fig. 50.	J60 second ethernet UTP connector	
Fig. 23.	USB-UART LIN0		Fig. 51.	PSI5 interface schematic	
Fig. 24.	LIN switch schematic		Fig. 52.	Physical PSI5 connector	
Fig. 25.	RCON switch schematic		Fig. 53.	MB user LEDs	
Fig. 26.	J244 with header schematic		Fig. 54.	MB user inputs	41
Fig. 27.	Daughtercard CAN0 and CAN1 connectors		Fig. 55.	S32SDEV-CON motor control connector	
Fia. 28.	CANXL connector	23		cable and socket	42

## S32Z280-594EVB Evaluation Board Solution for S32Z2 594MAPBGA Microcontrollers User Guide

4.9.1 4.9.2 4.10 4.11 **5** 

## **Contents**

1	Overview	2
-		
2	Boot modes	
2.1	Boot mode types	
2.2	Serial boot mode	
2.2.1	FlexCAN	
2.2.2	UART (LINFlexD)	5
2.3	Boot from external flash memory	
2.3.1	QSPI boot mode	
2.3.2	SD via uSDHC interface	7
2.3.3	Additional RCON settings for Clock/Speed/	
	Phase for different boot configurations	
3	Daughtercard	
3.1	Default jumper settings (DC)	9
3.2	Power supply1	2
3.2.1	Power from motherboard1	6
3.2.2	Power from multiple external supplies 1	6
3.2.3	Power from SBC/PMIC1	6
3.2.4	SBC/PMIC debug mode1	
3.3	Clock and reset 1	
3.3.1	Clocking 1	
3.3.1.1	40MHz crystal1	
3.3.1.2	40MHz OSC 1	
3.3.1.3	External SMA1	9
3.3.2	Reset 1	
3.3.2.1	POR RESET1	-
3.3.2.2	Functional Reset	
3.4	RCON switches	
3.5	LIN	
3.6	CAN	
3.7	CAN-XL 2	
3.8	SDHC	
3.9	EEPROM	
3.10	Ethernet	
3.10	Debug	
3.11 3.11.1	Aurora	
3.11.1 3.11.2		
3.11.2 3.11.3	JTAG	
3.11.3 3.11.4	Lauterbach Debuggers	0
3.11. <del>4</del> 3.11.5	Other	9
3.12	SPI	_
3.13	FLASH	
4	Motherboard3	
4.1	Power supply	
4.2	CAN	
4.2.1	CAN 0-3	
4.2.2	CAN 4-73	
4.3	LIN	
4.4	USB/UART3	
4.5	FlexRay3	
4.6	Ethernet	-
4.7	PSI5	
4.8	User LEDs4	
4.9	User Inputs4	1

Switches	41
Potentiometer	41
Motor control	42
Other connectors	42
Revision history	
Legal information	

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.